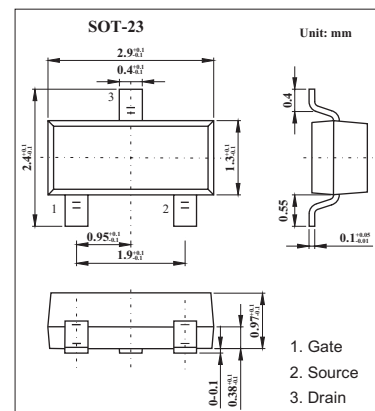
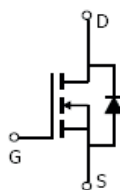


N-Channel Enhancement Mode Field Effect Transistor KO3414(AO3414)

■ Features

- $V_{DS} (V) = 20V$
- $I_D = 4.2A$ ($V_{GS}=4.5V$)
- $R_{DS(ON)} < 50m\Omega$ ($V_{GS} = 4.5V$)
- $R_{DS(ON)} < 63m\Omega$ ($V_{GS} = 2.5V$)
- $R_{DS(ON)} < 87m\Omega$ ($V_{GS} = 1.8V$)



■ Absolute Maximum Ratings $T_A = 25^\circ C$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 8	V
Continuous Drain Current *1 $T_A=25^\circ C$	I_D	4.2	A
Current *1 $T_A=70^\circ C$		3.2	
Pulsed Drain Current *2	I_{DM}	15	
Power Dissipation *1 $T_A=25^\circ C$	P_D	1.4	W
$T_A=70^\circ C$		0.9	
Thermal Resistance.Junction-to-Ambient *1	R_{thJA}	125	$^\circ C/W$
Thermal Resistance.Junction-to-Case	R_{thJC}	80	$^\circ C/W$
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ C$

*1The value of R_{thJA} is measured with the device mounted on 1in² FR-4 board with 2oz.

Copper, in a still air environment with $T_A = 25^\circ C$

KO3414(AO3414)

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{DSS}	I _D =250μA, V _{GS} =0V	20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =16V, V _{GS} =0V			1	μA
		V _{DS} =16V, V _{GS} =0V, T _J =55°C			5	
Gate-Body leakage current	I _{GSS}	V _{DS} =0V, V _{GS} =±8V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} I _D =250μA	0.4	0.6	1	V
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =4.2A		41	50	mΩ
		V _{GS} =4.5V, I _D =4.2A T _J =125°C		58	70	
		V _{GS} =2.5V, I _D =3.7A		52	63	
		V _{GS} =1.8V, I _D =3.2A		67	87	
On state drain current	I _{D(ON)}	V _{GS} =4.5V, V _{DS} =5V	15			A
Forward Transconductance	g _{FS}	V _{DS} =5V, I _D =4.2A		11		S
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =-10V, f=1MHz		436		pF
Output Capacitance	C _{oss}			66		pF
Reverse Transfer Capacitance	C _{rss}			44		pF
Gate resistance	R _g	V _{GS} =0V, V _{DS} =0V, f=1MHz		3		Ω
Total Gate Charge	Q _g	V _{GS} =4.5V, V _{DS} =-10V, I _D =4.2A		6.2		nC
Gate Source Charge	Q _{gs}			1.6		nC
Gate Drain Charge	Q _{gd}			0.5		nC
Turn-On DelayTime	t _{D(on)}	V _{GS} =4.5V, V _{DS} =10V, R _L =2.7Ω, R _{GEN} =6Ω		5.5		ns
Turn-On Rise Time	t _r			6.3		ns
Turn-Off DelayTime	t _{D(off)}			40		ns
Turn-Off FallTime	t _f			12.7		ns
Body Diode Reverse Recovery Time	t _{rr}	I _F =4A, di/dt=100A/μs		12.3		ns
Body Diode Reverse Recovery Charge	Q _{rr}	I _F =4A, di/dt=100A/μs		3.5		nC
Maximum Body-Diode Continuous Current	I _S				2	A
Diode Forward Voltage	V _{SD}	I _S =1A, V _{GS} =0V		0.76	1	V